



ZHCS750

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

## **Product Summary**

V <sub>RRM</sub>	I <sub>o</sub>	V <sub>F(MAX)</sub> @ 0.75A	I <sub>R(MAX)</sub> @ V <sub>R</sub> =30V
(V)	(A)	(V)	(μA)
40	0.75	0.49	100

# **Description and Applications**

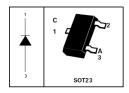
- DC DC Converters
- Mobile Telecomms
- PCMIA

## **Features and Benefits**

- High current capability (I<sub>F</sub> = 750mA)
- Low V<sub>F</sub>
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)



Top View

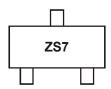
# **Ordering Information** (Note 4)

Device	Packaging	Shipping
ZHCS750TA	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



ZS7 = Product Type Marking Code



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Character	Symbol	Value	Units	
Continuous Reverse Voltage		V <sub>R</sub>	40	V
Continuous Forward Current		l <sub>F</sub>	750	mA
Forward Voltage @ I <sub>F</sub> = 750mA		V <sub>F</sub>	490	mV
Average Peak Forward Current; D.C. = 50%		I <sub>FAV</sub>	1500	mA
Non Repetitive Forward Current	t ≤ 100μs	I <sub>FSM</sub>	12	А
	t ≤ 10ms		5.2	А

## **Thermal Characteristics**

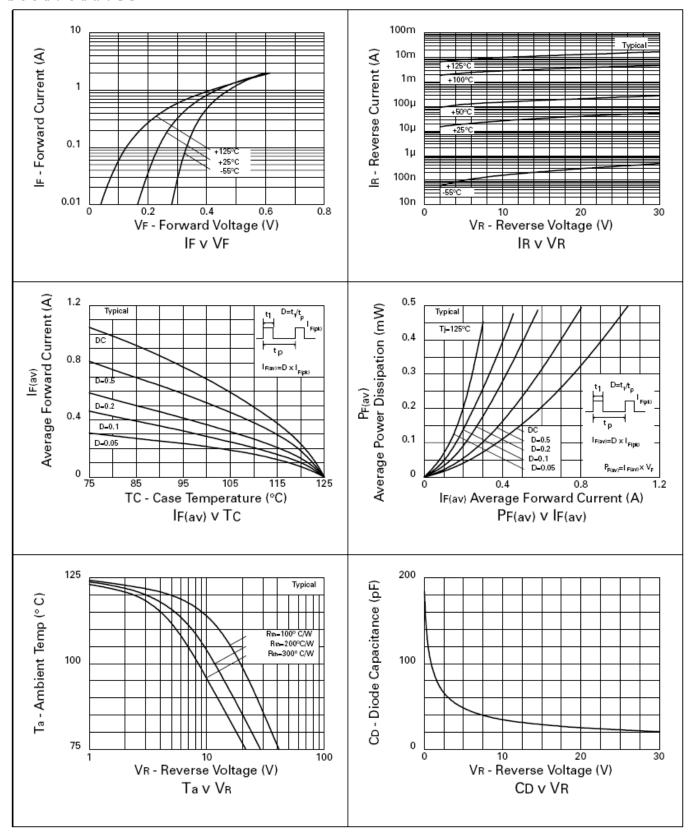
Characteristic	Symbol	Value	Unit
Power Dissipation, T <sub>A</sub> = +25°C	P <sub>D</sub>	500	mW
Junction Temperature	TJ	125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

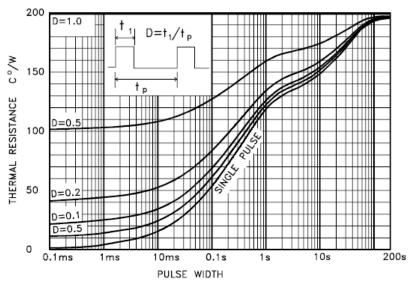
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	40	60	_	V	I <sub>R</sub> = 300μA
	V <sub>F</sub>	_	225	280	mV	I <sub>F</sub> = 50mA
		_	235	310		I <sub>F</sub> = 100mA
		_	290	350		I <sub>F</sub> = 250mA
Forward Voltage (Note 5)		_	340	420		I <sub>F</sub> = 500mA
		_	390	490		I <sub>F</sub> = 750mA
		_	440	540		I <sub>F</sub> = 1A
		_	530	650		I <sub>F</sub> = 1.5A
Reverse Current (Note 6)	I <sub>R</sub>	_	50	100	μΑ	V <sub>R</sub> = 30V
Diode Capacitance	C <sub>D</sub>	_	25	_	pF	f = 1MHz, V <sub>R</sub> = 25V
Reverse Recovery Time	Trr	_	12	_	ns	Switched from $I_F$ = 500mA to $I_R$ = 500mA Measured @ $I_R$ = 50mA

5. Measured under pulsed conditions. Pulse width =  $300\mu$ S. Duty cycle  $\leq 2\%$ . 6. Short duration pulse test used to minimize self-heating effect. Notes:





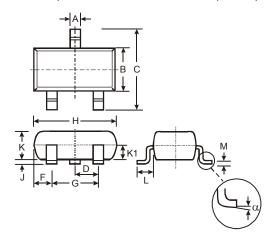




MAXIMUM TRANSIENT THERMAL RESISTANCE\*

# **Package Outline Dimensions**

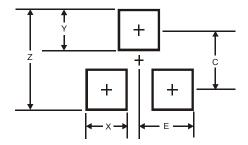
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)		
Z	2.9		
X	0.8		
Υ	0.9		
С	2.0		
E	1.35		

<sup>\*</sup> Reference above figure, devices were mounted on a 15mmx15mm ceramic substrate.



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